

# AO4892-VB Datasheet

Dual N-Channel 100 V (D-S) MOSFET

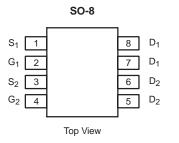
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
100	0.0360 at V <sub>GS</sub> = 10 V	6.4	23 nC			
100	0.0375 at V <sub>GS</sub> = 8 V	5.5	23110			

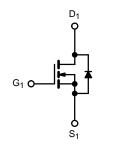
## FEATURES

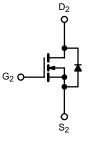
- Halogen-free According to IEC 61249-2-21
  Definition
- Extremely Low Q<sub>gd</sub> for Switching Losses
- 100 % R<sub>g</sub> Tested
- 100 % Avalanche Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

• Primary Side Switch







N-Channel MOSFET

N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	100	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
	T <sub>C</sub> = 25 °C		6.4		
Continuous Drain Current (T 150 °C)	T <sub>C</sub> = 70 °C	1 . Г	5.1		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C		5.5 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1 –	4.5 <sup>b, c</sup>	Α	
Pulsed Drain Current		I <sub>DM</sub>	26	A	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		4.5		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	۱ <sub>S</sub>	2.6 <sup>b, c</sup>		
Single Pulse Avalanche Current L = 0.1 n		I <sub>AS</sub>	20		
Single Pulse Avalanche Energy	L = 0.1 mm	E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C		5.9		
Maximum Dower Dissinction	T <sub>C</sub> = 70 °C		3.8	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.1 <sup>b, c</sup>	VV	
	T <sub>A</sub> = 70 °C	1 F	2 <sup>b, c</sup>		
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, †</sup>	t ≤ 10 s	R <sub>thJA</sub>	33	40	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	17	21	0/11		

Notes:

a. Based on T<sub>C</sub> = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 80 °C/W.

RoHS COMPLIANT HALOGEN FREE Available



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	· · · · ·			<u> </u>	•	•
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = 250 \mu A$	100			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			172		
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 10		mV/°0
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	2.5		4.5	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	
Zero Gate Voltage Drain Current	DSS	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$			10	μA
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			Α
		$V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$	0.0360			Ω
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 8 V, I_{D} = 5 A$				
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 5 A		23		S
Dynamic <sup>b</sup>				<u> </u>		
Input Capacitance	C <sub>iss</sub>			1735		
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, f = 1 MHz		160		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			37		
Total Gate Charge	Q <sub>g</sub>	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$		28.5	43	
				23	35	nC
Gate-Source Charge	Q <sub>qs</sub>	$V_{DS} = 75 \text{ V}, V_{GS} = 8 \text{ V}, I_{D} = 5 \text{ A}$		8		
Gate-Drain Charge	Q <sub>qd</sub>			6.5		
Gate Resistance	R <sub>g</sub>	f = 1 MHz		0.85	1.3	Ω
Turn-on Delay Time	t <sub>d(on)</sub>			14	21	-
Rise Time	t <sub>r</sub>	$V_{DD}$ = 50 V, $R_{L}$ = 10 $\Omega$		12	18	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, \text{R}_g = 1 \Omega$		22	33	
Fall Time	t <sub>f</sub>			6	10	
Turn-On Delay Time	t <sub>d(on)</sub>			16	24	- ns -
Rise Time	t <sub>r</sub>	$V_{DD}$ = 50 V, $R_L$ = 10 $\Omega$		12	18	
Turn-Off Delay Time	t <sub>d(off)</sub>	${\sf I}_{\sf D}\cong$ 5 A, ${\sf V}_{\sf GEN}$ = 8 V, ${\sf R}_{\sf g}$ = 1 $\Omega$		20	30	
Fall Time	t <sub>f</sub>			7	12	
Drain-Source Body Diode Characteristic	cs					
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			7.7	^
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				50	A
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 2.6 A		0.77	1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			63	95	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			110	165	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 \text{ °C}$		49		
Reverse Recovery Rise Time	t <sub>b</sub>			14		ns

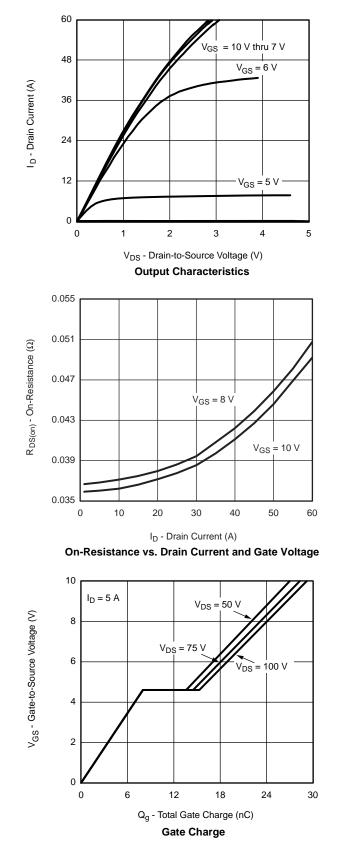
Notes:

a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%$ 

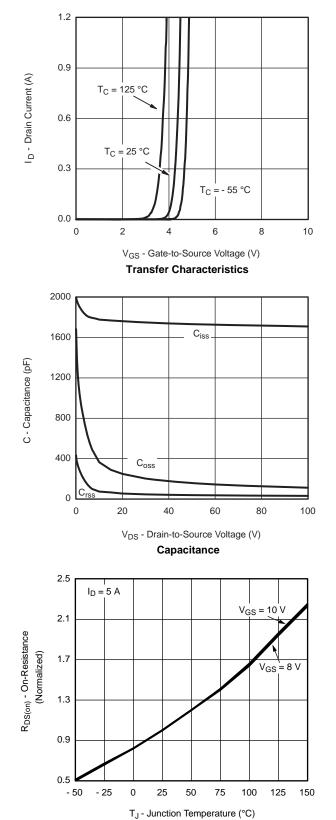
a. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





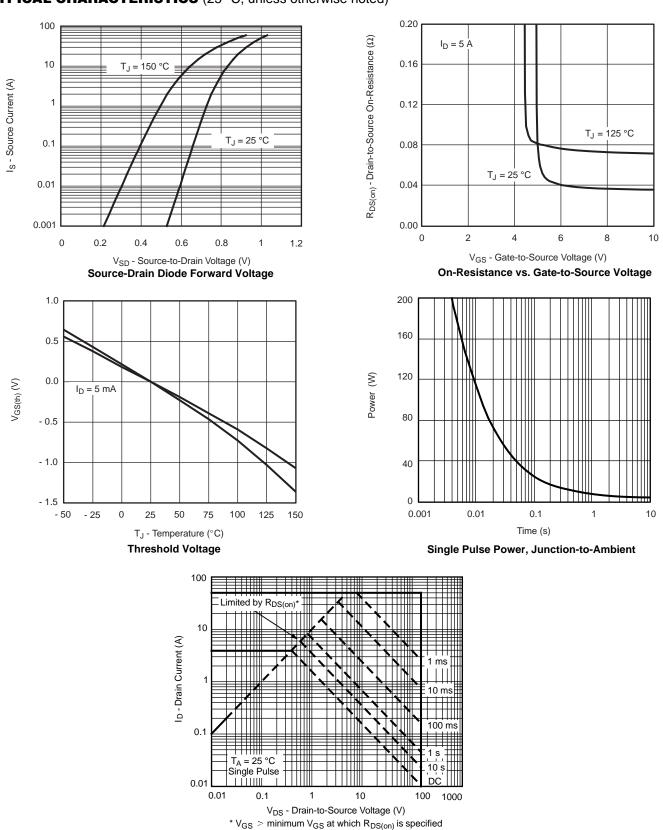
#### **TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



**On-Resistance vs. Junction Temperature** 

服务热线:400-655-8788





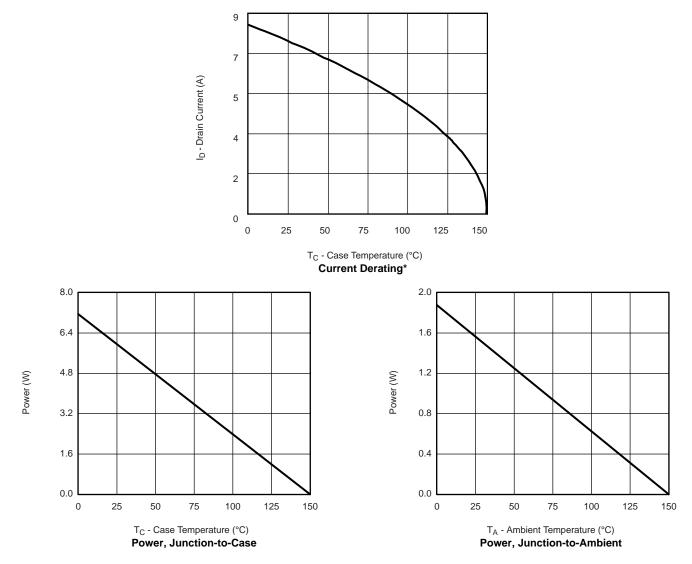
Safe Operating Area, Junction-to-Ambient

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





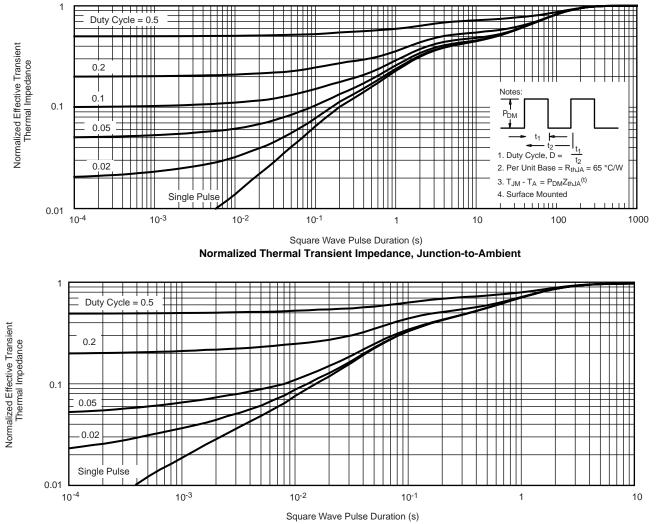
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



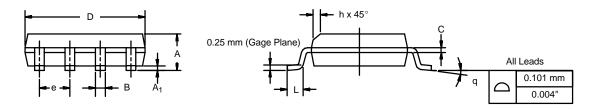
Normalized Thermal Transient Impedance, Junction-to-Foot



# SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

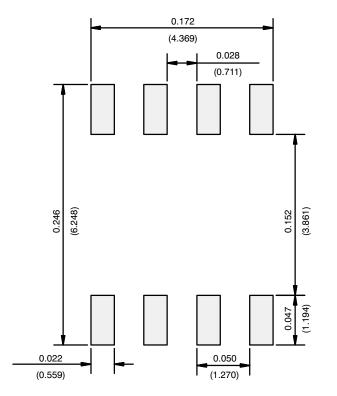




	MILLIM	ETERS	INCHES			
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						



### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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